









Application Fields:

- Power Supply, e.g. DC/DC converters, DC/AC inverters, Backlight drivers, etc.
- Consumer Electronics, e.g. LCD TVs, PDP, DVDs, PCM, etc.
- Communication Technology, e.g. Telecom systems, Networking, Modems, Routers, Changers, Base stations, etc.
- Office Automation Electronics
- IT Products, e.g. LCD monitors, Notebooks, PC servers, etc.

Clearing Time Characteristics:

% of Current Rating	Clearing Time at 25°C			
100%	4 hours min.			
200%(0.50~10.0 A)	0.01 seconds min.	5 seconds max.		
200%(12.0~20.0 A)	0.01 seconds min.	20 seconds max.		

Agency Approval:

- Recognized Under the Components Program of Underwriters Laboratories. File Number: E232989
- PSE Certificate No: NBK180711-JP13710
- TUV File Number: 50209083CQC No.: CQC11012065955

Patents:

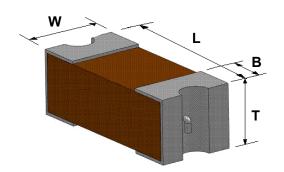
Patent numbers "ZL200810092353.3", "ZL200910007157.6", "ZL201120450579.3", "ZL201120536307.5", "ZL201220063222.4", "ZL201110123326.X".

Features:

- Fast acting at 200% overload current level
- Excellent inrush current withstanding capability
- Fiberglass enforced epoxy fuse body
- Copper or copper alloy composite fuse link
- Copper termination with nickel and tin plating
- Halogen free, RoHS compliant and 100% lead-free
- Operating temperature range: -55°C to +125°C (with derating)

Shape and Dimensions:

Unit	Inch	mm		
L	0.240 ± 0.006	6.10 ± 0.15		
w	0.098 ± 0.006	2.49 ± 0.15		
Т	0.085 ± 0.008	2.16 ± 0.20		
В	0.053 ± 0.015	1.35 ± 0.38		











Ordering Information:

Part Number	Current Rating	Voltage Rating (V)		Interrupting Rating	Nominal Cold DCR	Nominal I ² t	Agency Approval				Marking (Optional) ³
	(A)	AC	DC		$(\Omega)^1$. / / ^ ~ ^ ~		PSE	TUV	CQC	(Spaisinal)
AF2-0.50V125TM	0.5				0.231	0.10	√		√	√	С
AF2-0.63V125TM	0.63			TUV:	0.174	0.16	√		√		S
AF2-0.75V125TM	0.75			0.5 ~ 2 A 100 A @ 250 VAC	0.148	0.23	√				D
AF2-1.00V125TM	1.0	250		50 A @ 125 VDC	0.093	0.59	~	√	>	√	Е
AF2-1.25V125TM	1.25			cqc:	0.07	0.96	~	√	>		F
AF2-1.50V125TM	1.5			0.5 A、1 A、2 A 100 A @ 250 VAC	0.062	1.19	>	√			G
AF2-2.00V125TM	2.0			50 A @ 125 VDC	0.042	2.75	√	√	√	√	1
AF2-2.50V125TM	2.5			PSE:	0.031	1.21	√	√			J
AF2-3.00V125TM	3.0		405	1 ~ 5 A	0.0249	1.73	√	√			К
AF2-3.15V125TM	3.15		125	50 A @ 125 VAC	0.0232	2.2	√	√			V
AF2-3.50V125TM	3.5			UL: 0.5 ~ 2 A	0.022	2.5	√	√			L
AF2-4.00V125TM	4.0			100A @ 250VAC 1.5 ~8 A	0.0172	4.1	√	√			М
AF2-5.00V125TM	5.0	125		50A @125VAC 0.5 ~ 8 A	0.0143	5.9	√	√			N
AF2-6.30V125TM	6.3			50 A @ 125 VDC	0.01	12.5	√				0
AF2-7.00V125TM	7.0			300 A @ 32 VDC	0.0094	14.2	√				Р
AF2-8.00V125TM	8.0				0.0086	20.3	√				R
AF2-10.0V125TM	10.0			35 A@ 125 VAC 50 A @ 125 VDC 300 A @ 32 VDC	0.0066	29.2	√				Q
AF2-12.0V065TM	12.0			50 A @ 65 VAC	0.0053	49.2	√				Х
AF2-15.0V065TM	15.0	65	65	50 A @ 65 VDC 300 A @ 32 VDC	0.0038	102.5	√				Y
AF2-20.0V065TM	20.0	00	05	50 A @ 65 VAC 100 A @ 65 VDC 300 A @ 32 VDC	0.0034	126.2	√				Z

Measured at ≤ 10% rated current and 25°C ambient.
 Melting I²t at 0.001 second pre-arcing time.
 White Marking Character Code.

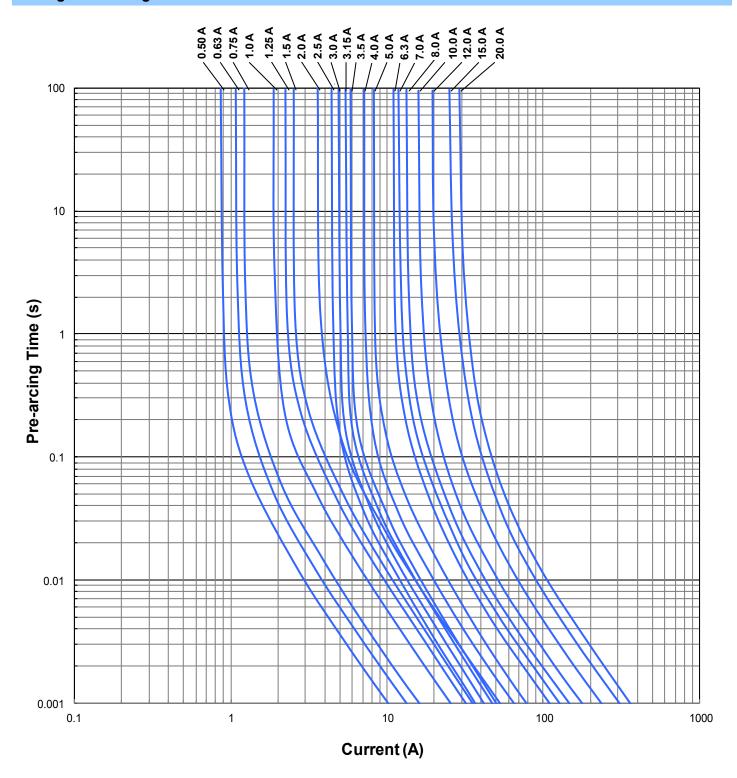








Average Pre-arcing Time Curves:



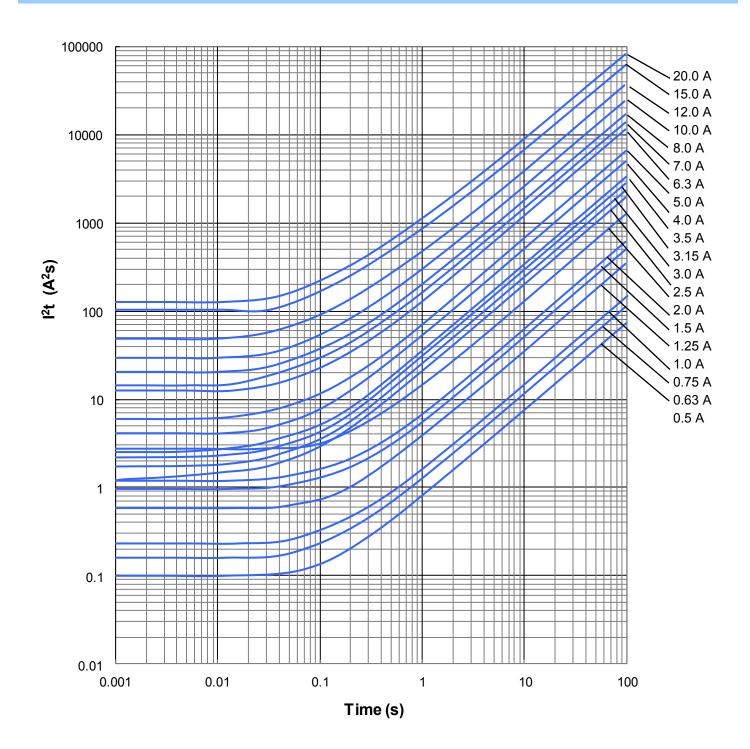








Average I²t vs. t Curves:











AirMatrix® Surface Mount Fuses

Product Identification:

AF2 1.00 V125 T M

(1) (2) (3) (4) (5)

(1) Series Code: AF2

(2) Current Rating Code: 1.00—1.00A
(3) Voltage Rating Code: V125—125VDC
(4) Package Code: T - Tape & Reel, B - Bulk

(5) Marking Code: M - With Marking

AF 1206 F 2.00 T M

(1) (2) (3) (4) (5) (6)

(1) Series Code: AF—AF Series, MF—MF Series

(2) Size Code: Standard EIA Chip Sizes(3) Time/Current Characteristic: F

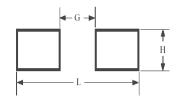
(4) Current Rating: 2.00—2.00A

(5) Package Code: T - Tape & Reel, B - Bulk

(6) Marking Code: M - With Marking

Recommended Land Pattern:

	Al	F2	AF1	AF1206		MF2410		MF1210	
	Inch	mm	Inch	mm	Inch	mm	Inch	mm	
L	0.338	8.60	0.173	4.40	0.338	8.60	0.170	4.40	
G	0.118	3.00	0.059	1.50	0.118	3.00	0.070	1.70	
Н	0.124	3.15	0.071	1.80	0.110	2.80	0.110	2.70	



Packaging:

Chip Size	Parts on 7 inch (178 mm) Reel			
2410 (6125)	2,000			
1210 (3225)	2,500			
1206 (3216)	3,500			

Storage:

The maximum ambient temperature shall not exceed 35° C . Storage temperatures higher than 35° C could result in the deformation of packaging materials.

The maximum relative humidity recommended for storage is 75%. High humidity with high temperature can accelerate the oxidation of the solder plating on the termination and reduce the solderability of the components.

Sealed vacuum foil bags with desiccant should only be opened prior to use.







AirMatrix® Surface Mount Fuses

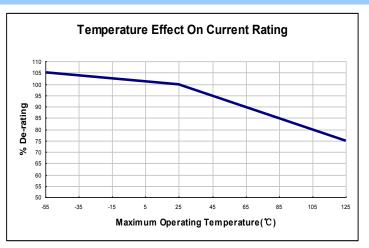
Fuse Selection and Temperature De-rating Guideline:

The ambient temperature affects the current carrying capacity of fuses. When a fuse is operating at a temperature higher than 25°C, the fuse shall be "derated".

To select a fuse from the catalog, the following rule may be followed:

Catalog Fuse Current Rating = Nominal Operating Current / 0.75 / % De-rating at the maximum operating temperature.

Example: At maximum operating temperature of 65°C, % De-rating is 90%. The nominal operating current is 4 A. The current rating for fuse selected from the catalog shall be:



Environmental Tests:

Reliability Test	Test Condition and Requirement	Test Reference	
Reflow & Bend	3 reflows at 245°C followed by a 2 mm bend, 20% DCR change max. (10% for ≤ 1 A), no mechanical damage		
Solderability	245°C, 5 seconds, new solder coverage 90% minimum	MIL-STD-202 Method 208	
Soldering Heat Resistance	260°C, 10 seconds, 20% DCR change max. (10% for ≤ 1 A), new solder coverage 75% minimum	MIL-STD-202 Method 210	
Life	25°C, 2000 hours, 80% rated current (75% for < 1 A), voltage drop change≤ ±20%	Refer to AEM QIQ106	
Thermal Shock	-65°C to +125°C, 100 cycles, 10% DCR change max., no mechanical damage	MIL-STD-202 Method 107	
Mechanical Vibration	5 – 3000 Hz, 0.4 inch double amplitude or 30 G peak, 10% DCR change max., no mechanical damage	MIL-STD-202 Method 204	
Mechanical Shock	1500 G, 0.5 milliseconds, half-sine shocks, 10% DCR change max., no mechanical damage	MIL-STD-202 Method 213	
Salt Spray	5% salt solution, 48 hour exposure, 10% DCR change max., no excessive corrosion	MIL-STD-202 Method 101	
Moisture Resistance	10 cycles, 15% DCR change max., no excessive corrosion	MIL-STD-202 Method 106	





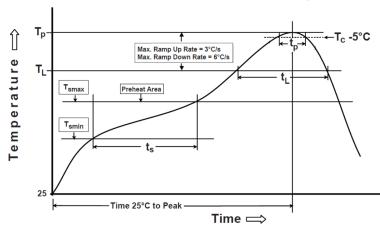




AirMatrix® Surface Mount Fuses

Soldering Temperature Profile:

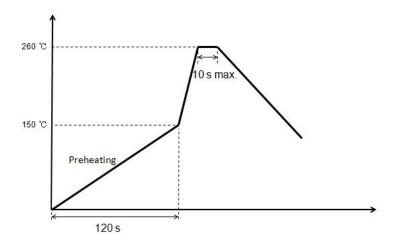
* Recommended Temperature Profile for Reflow Soldering



	Pb-Free
Profile Feature	Assembly
Preheat/Soak	
Temperature Min (T _{smin})	150°C
Temperature Max(T _{smax})	200°C
Time(t_s) from (T_{smin} to T_{smax})	60~120 seconds
Ramp-uprate (T _L to T _p)	3°C/second
ramp aprate (TE to Tp)	max.
Liquidous temperature(T _L)	217°C
Time(t _L) maintained above T _L	60~150 seconds
Peak package body temperature (T _p)	260°C
Time (t _p)*within 5°C of the specified classification temperature (T _c)	30 seconds *
Ramp-down rate (T _p to T _L)	6°C/second max.
Time 25°C to peak temperature	8 minutes max.

 $^{^{\}star}$ Tolerance for peak profile temperature (T_{p}) is defined as a supplier minimum and a user maximum

* Recommended Temperature Profile for Wave Soldering







Disclaimer

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